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Bluetooth 2.1 Single Chip for HCI Solution

General Description

The CONWISE CW6626 is a monolithic, single-chip, stand-alone baseband process with an integrated 2.4GHz transceiver for Bluetooth 2.1 applications. It is fully compliant with Bluetooth 2.1 features such as Simple Paring (SP), Enhanced Inquiry Response (EIR) and Sniff Subrating. The CW6626 is also completely backward-compatible with Bluetooth 1.1/1.2/2.0 specification. It eliminates the need for external flash memories and active components into the device. Thus minimizing the footprint and system cost of implementing a Bluetooth system.

The CW6626 has been designed in 0.18um RF CMOS technology, the most cost-performance effective silicon process today. This use of the advanced process enables the CW6626 to achieve the lowest cost total solution and maintain the possible lower current consumption in all modes of operation.

The CW6626 is the optimal solution for any voice and/or data applications that requires the Bluetooth SIG standard Host Controller Interface (HCI) via either USB or UART and PCM audio interface. The CW6626 also includes industry collaborative coexistence solution with WLAN system such 2-wire, 3-wire or 4-wire interfaces.

Features

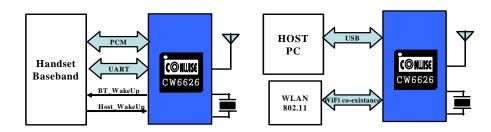
- Bluetooth specification version 2.1 compatible.
- Support ACL multi-slot packets for Data/Audio stream application.
- Support SCO/eSCO link with external PCM digital audio interface.

- Support high-speed UART baud rate of up to 3Mps, USB 2.0 full-speed compliant interface for HCI transport
- Support AFH for WiFi coexistence.
- Optimal coexistence with WLAN PTA/GPIO
 2-wire, 3-wire or 4 wire interfaces
- On-chip ROM eliminates dedicated flash memory chip, significantly lowering system BOM.
- Integrated 8-bit 8051 microprocessor core instead of ARM/MIPS such high cost processors.
- External Clock/Crystal 13M, 16M and 26MHz system clocks are available to apply for system requirement.
- Optional external 32K or 32.768KHz crystal/clock for deep-low power mode using.
- Wide operation voltage: 2.8V~5.5V.
- Package types available

CW6626M: 48pin QFN package (6mm x 6mm)

Applications

- Mobile and portable communication devices
- PDA, PND and low-power embedded communication devices
- PC and Notebook on mother boards application
- LCD Digital TV, Digital camera, Digital Photo Frame and other high-volume consumer product



Typical Mobile Phone Application

Typical PC/NoteBook Application





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Revision History

Revision	Date	Originator	Change Description
V0.1	2008/1/13	J.Y. Hsu	Draft version initial release
V0.2	2008/7/21	J.Y. Hsu	Update:
			 Add new package QFN6x6 48pin for size critical application
			 Remove SPI function due to pin count issue
			 Upgrade Bluetooth Specification to 2.1 from 2.0
V1.0	2008/9/28	J.Y. Hsu	Update:
			Official version released
			 Added 20M, 26M, 32M and 40MHz clock options for difference clock system application
			• Put $\pi/4$ -DQPSK and 8-DPSK RF specification for EDR
			Update application circuit
V1.1	2009/4/12	J.Y. Hsu	Update:
			• Delete CW6626F package(phase out)
			 delete 12, 20M, 32M and 40MHz clock options
			add Pin-CNR description
			 change the MOQ of Tape&Reel



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1. Overview

The CW6626 is Bluetooth Core Specification version 2.1 compliant and designed for used in standard HCI (Host Control Interface) UART or USB application. The combination of the Radio Transceiver, BBC and the 8051-based microcontroller-BLM, BIM with on-chip ROM provide a complete lower layer Bluetooth protocol stock including the link controller (LC), link manger (LM), and HCI interface. The major features of CW6626 are listed in section 1.1 and two common usage models-Cellular phone and PC are described in following section 1.2 and 1.3.

1.1. Features

- Major features of the CW6626 include:
- Fully supports Bluetooth 2.1 features
- Adaptive Frequency Hopping (AFH)
- Scatter Mode
- OoS
- eSCO
- Fast Connect
- LMP improvements
- Synchronization
- Built-in regulators
- Built-in TR switch
- Maximum UART baud rates of 3 Mbps
- Support maximum Bluetooth data rates over HCI UART, USB interfaces
- Multipoint operation with up to 7 active slaves
- Scatternet operation with up to 4 active piconets with background scan and support for scattermode
- High speed HCI UART transport support
- HCI USB transport support with USB version 2.0 full-speed compliant interface
- Channel quality driven data rate and package type selection
- Extended radio and production test mode features
- Full support for power saving modes
- Built-in LPO clock using external 32K or 32.768KHz crystal/clock

1.2. Mobile Phone Usage Model

The CW6626 is designed to provide direct interface with new and existed cellular phone designs as show in figure 1. The CW6626 has very flexible PCM and UART interface enabling it to transparently connect with existing circuits. In addition, the TCXO and external LPO (Low Power Oscillator) inputs allows the use of existing features of the handset to further minimizing the size, power and cost of the integration.

The CW6626 incorporates a number of unique features to accommodate the integration into mobile phone platforms.

Ver 1.1 Apr/12/2008

CW6626 Product Datasheet



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- The PCM interface provides multiple modes of operation to support both master and slave as well as interfacing to single external codec devices (eg. CONWISE CW669x CODEC series and CW668x MCU+CODEC series).
- The UART interface supports hardware flow control with tight integration to power control side band signalling to support the lowest power operation.
- The TCXO interface provides three frequencies-13M, 16M and 26MHz to accommodate the typical reference frequencies used by mobile phone.
- A programmable TCXO power-up or power-down signal allows the device to indicate when the clock supplied to the CW6626 may be disabled for added power saving during sleep mode.
- Both the TCXO and external LPO inputs are high impedance inputs that have minimal loading on the driving source.
- The highly linear design of the radio transceiver ensures that the device has the lowest output spurious emissions regardless of the stat of operation and has been fully characterized in the global cellular bands.
- The transceiver design has excellent blocking (eliminating desensitization of the Bluetooth receiver) and inter-modulation performance (distortion of the transmitted signal caused by the mixing of the cellular and Bluetooth transmissions) in the presence of a any cellular transmission (GSM, GPRS, CDMA, WCDMA or TDS-CDMA). Minimal external filtering is required for integration inside the handset.
- Minimal external components are required for integration and very compact packaging is available.

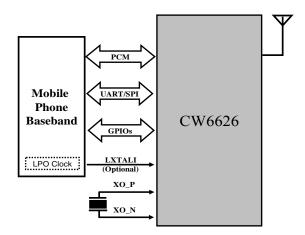


Figure 1 Mobile Phone Usage Model

1.3. PC/NB Usage Model

The CW6626 can be directly interfaced using the HCI USB interface and fully supports embedded USB applications such as PC motherboard integration and Notebook, or as an external USB dongle peripheral device. Figure 2 shows an example of a PC product usage model.



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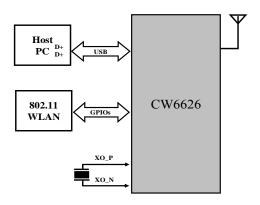


Figure 2 PC/Notebook Usage Model



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2. Functional Description

The CW6626 integrates an Bluetooth Radio Transceiver (BRT) that has been optimized for use in 2.4GHz Bluetooth wireless system and Bluetooth Baseband Core (BBC) for Bluetooth Link Control Layer processing, Bluetooth Link Manager (BLM) for up to Blutooth HCI layer handling, Bluetooth Interface Manager (BIM) to communicate with external host processor, GPIO block is controlled by firmware running on the BLM/BIM for specified functions and applications, Clock Management block for internal clock scheme and Power Management for whole system power supplying, Battery Low Detector is designed to detect the supply power status. Figure 3 shows the device block diagram of CW6626.

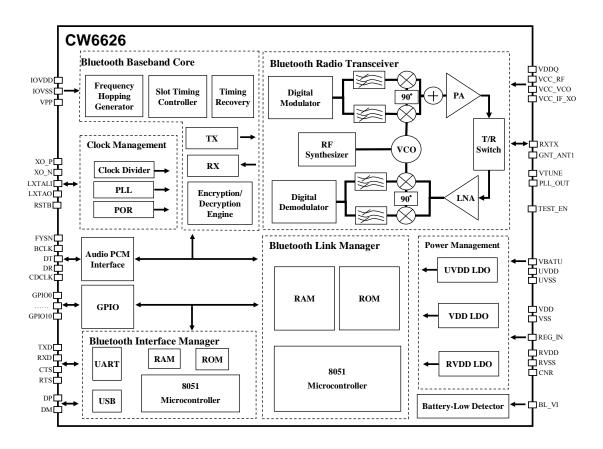


Figure 3: CW6626 Device Block Diagram

2.1. Bluetooth Radio Transceiver

The CW6626 has an integrated radio transceiver that has been optimized for use in 2.4GHz Bluetooth wireless systems. It has been designed to provide low-power, low-cost, robust communications for



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applications operating in the globally available 2.4GHz unlicensed ISM band. It fully compliant with the Bluetooth Radio Specification and meets or exceeds the requirements to provide the highest communication link quality of service. The radio completely integrated the receiver and transmitter baluns, the antenna filter and switch together with the VCO tank on single die. The fractional-N delta-sigma synthesizer and internal crystal calibration offer support for wide range of external reference frequency clocks or TCXO. The digital Received Signal Strength Indicator (RSSI) allows for efficient power control and communication. Several current saving modes are available.

2.1.1. Transmitter Path

The CW6626 features a fully integrated zero IF transmitter. The basedband transmit data is digitally GFSK modulated in the modulator block and up-converted to the 2.4GHZ ISM band in the transmitter path consists of signal filtering, I/Q up-conversion, output power amplifier (PA), and RF filtering.

2.1.1.1. **IQ** Modulator

The transmitter features a direct IQ modulator to minimize the frequency drift during a transmit timeslot, which results in a controlled modulation index. Digital baseband transmit circuit provides the required spectral shaping.

2112 Power Amplifier

The internal Power Amplifier (PA) has maximum output power of +4dBm. This allows CW6626 to be used in class-2 and class 3 radio without an external RF PA.

2.1.2 Receiver

The receiver features a low IF scheme to down-convert the received signal for demodulation in the digital demodulator a bit synchronizer. The receiver path provides a high degree of linearly, an extended dynamic range, and high order on-chip channel filtering to ensure reliable operation in the noisy 2.4GHz ISM band.

2.1.2.1. IQ Demodulator

The digital IQ demodulator takes the low IF received signal an optimal frequency tracking and bit synchronization algorithm.

2 1 2 2 Receiver Signal Strength Indicator (RSSI)

The radio portion of the CW6626 provides an RSSI signal to the baseband so that the BLM can take part in the Bluetooth power-controlled link by providing a metric of its own receiver signal strength to determine whether the transmitter increase or decrease it output power.

Synthesizer 2.1.3.

The CW6626 features a fractional-N sigma-delta synthesizer which consists of a phase detector, a charge pump, a low-pass loop filter, a programmable frequency diver, a voltage-controlled oscillator (VCO), a sigma-delta modulator and a loop-up table.

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2.2. Bluetooth Baseband Core

The Bluetooth Baseband Core(BBC) implements all of the timing critical functions required for high preference Bluetooth operation. The BBC manages the buffering, segmentation and routing data for all connections. It also buffers data that passed through it, handles data flow control, schedule ACL TX/RX transactions, monitors Bluetooth slot usage, optimally segments and packages data into baseband packets, manages connection status indicators and composes and decode HCI packets. The BCC provides elementary control and processing of baseband packets. The CW6626 supports all the ACL packet types defined in Bluetooth specification. It consists of blocks for slot timing control, frequency hopping, encryption/decryption engine, transmitter and receiver. The ACL rate buffers are also included here.

2.2.1. Transmitter(TX)

Transmitter contains the modules performing access code generation, HEC generation, data whitening, FEC generation and CRC generation.

2.2.2. Receiver(RX)

Receiver provides the same functions as that of transmitter with the reverse direction.

Encryption/Decryption Engine 2.2.3.

Encryption/Decryption Engine supports the maximum (128-bit) encryption key length. The effective encryption key length that can be manufacturer/application-dependent is negotiated by the two devices before encryption starts. Then the final encryption key is derived by the Bluetooth Link Manager according to Bluetooth spec. The engine generates the cipher stream that is routed to both transmitter and receiver for payload encryption and decryption.

2.2.4. Frequency Hopping Generator

Frequency Hopping Generator performs the hop frequency calculation. It supports both 23-hop and 79-hop systems, as well as the half slot hopping needed within inquiry, inquiry scan, page and page scan states.

2.2.5. Slot Timing Controller

Slot Timing Controller provides all the timing signals for the transmitter and receiver, as well as the sync word detection.

Timing Recovery 2.2.6.

Timing Recovery blocks restructures the Bluetooth data clock from the received un-processed Bluetooth data.

2.3. Bluetooth Link Manager-8051 Microcontroller

The Bluetooth Link Manager (BLM) is an enhanced performance 8051 microcontroller and consists of an internal register RAM, an internal data SRAM and an application program ROM. The BLM runs software from the Link Control (LC) layer, up to the host controller interface (HCI). The BLM handles the essential baseband processes such as link set-up, security, QoS, etc. Moreover, it also serves as a part of the Link Controller (LC). It responds to the following jobs:

atasheet constants

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Determination of state transition

According to current status and the settings from Host, BLM decides the state transition and the usage of next time slot.

LMP messages processing

LMP messages contain various commands concerning security such as authentication, paring, encryption key size, etc., as well as state management like hold mode, sniff mode and park mode. Besides, link policy commands such as *channel quality-driven data rate* and *quality of service* are also handled by BLM. Moreover, the power control for both baseband and RF module are accomplished by the BLM.

Link layer flow control

The BLM is responsible for ACL link flow control.

Authentication key and encryption key generation

Authentication is mandatory for a Bluetooth device. The BLM is responsible for authentication key and encryption key generation. Certain tables for deriving these keys are necessary.

Control in test modes

In test modes, there are mainly two test items: transmitter test and loopback test. The BLM makes additional operations on both payload and frequency hop control which do not occur in the normal mode.

HCI packet processing

There are three types of HCI packets: command packets, event packet, and data packets. The BLM receives the command packets from Host and makes response. Then the event packets are sent to the Host for status report. To transmit data over the air interface, the HCI data packets need to be segmented into baseband packets such as DM1 and DM3 accordingly. In the receiving path, these baseband packets are reassembled to HCI data packets. The operations of segmentation and reassembly are accomplished by BLM.

DMA channel control

DMA channels provide high-speed data transfer between several data buffers. The channels are also under the control of BLM.

2.4. Bluetooth Interface Manager-8051 Microcontroller

The Bluetooth Interface Manager (BIM) is an enhanced performance 8051 microcontroller and consists of one UART port, one USB port, an internal register RAM, an internal data SRAM and an application program ROM. The BIM responds for the physically transport protocol processing. For HCI RS232, it processes the COBS if needed. As for USB, it manages the device address, monitors the status of the transaction, and manages the FIFOs. After removing the redundant information in any type of transport layer, the BIM moves data to a FIFO connecting to the BLM.

2.4.1. UART

The CW6626 provides standard 4-wire interface (TXD, RXD, RTS, CTS) UART port with adjustable baud rates from 1200bps to 3,0Mbps by internal setting registers. The interface supports the Bluetooth 2.0 UART HCI specification. The CW6626 has added the capability to perform wake-on-activity, where is can be asleep and have activity on the RXD or CTS input can wake up the chip.

2.4.2. Audio PCM Interface

The Audio PCM Interface on the CW6626 can connect to linear/A-law/Mu-law PCM CODEC devices in master or slave mode. In the master mode, the CW6626 generates the FSYN and BCLK signals, and

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in salve mode, these signals are provided by another master on the PCM interface and are inputs to the CW6626.

2.4.3. USB

The CW6626 provides a full speed Universal Serial Bus (USB) interface for communicating with other compatible digital devices. The CW6626 acts as a USB peripheral, responding to request from a master host controller such as a PC.

2.5. GPIO Port

The CW6626 has a total of 11 General Purpose I/Os(GPIOs) GPIO0~10. These are controlled by firmware running on the device. All of I/Os are 3.3 tolerant, COMS, programmable pull-ups.

2.6. Clock Management

The CW6626 uses two different frequency references for normal and low-power operational modes. And external crystal or external frequency reference driven by a temperature compensated crystal oscillator (TCXO) signal is used for the generated of all of radio frequencies and normal operating clocking. The acceptable frequency rates are 13M, 16M and 26MHz. The XO P and XO N pins are used to connect an external crystal to provide a frequency reference. Either an external 32.768KHz (32KHz also acceptable) crystal is connected between LXTALI and LXTALO pin for low power mode timing. The RSTB pin is used to reset whole system of CW6626 to initial state. The Clock Management block includes three sub-blocks for whole system clocking and resetting: Power-On Reset block is used to completely reset all circuits to a known power on state, Clock Divider block is used generated corresponding different system clocks for whole system using and PLL block is used to generated higher reference clock as internal BBC and microcontrollers system clock..

2.6.1. Power-On Reset (POR)

The CW6626 has an integrated power-on reset circuit which will completely reset all circuits to a know power on state. This action can also be driven by an external reset signal which can be used to externally control the device, forcing it into a power-on reset state. The RSTB pin is an active low signal and is not required to be connected in most applications. No external pull-up resistor is required.

Clock Divider 2.6.2.

The Clock Divider unit is used to generate the corresponding clock frequency for each sub-system of CW6626. The CW6626 adopts the clock gating technical to reduce the power-consumption for better battery life cycle in portable device. Each block of CW6626 is work well under the suitable clock rate to prevent any extra redundancy power consumption.

2.6.3. PLL.

The PLL block is used to generate high system clock for normal operational mode using and the external main reference clock its reference source.

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2.7. Power Management

The Power Management unit has three on-chip linear regulators: UVDD LDO, VDD LDO and RVDD LDO. The UVDD LDO regulator is dedicated to supply internal USB transceiver with 3.3V/3.0V/2.8V and 2.5Vdc selectable output. The VDD LDO regulator supplies the whole digital core of CW6626 with 1.8V/1.65Vdc selectable output. The RVDD LDO regulator provides 2.75V/2.6V/2.5Vdc selectable output to the internal RF circuits of CW6626.

UVDD LDO 2.7.1.

The UVDD LDO regulator is a 3.3Vdc linear regulator which can be used to power the internal USB transceiver when USB port is adopted in the application. The UVDD pin is the output node and needs to connect a decoupling circuit to UVSS for best performance showing. This regulator is operating from single 3.7V to 5.5V of input supply form VBATU pin with less than 50mV of maximum dropout voltage at full load (70mA).

2.7.2. VDD LDO

The VDD LDO regulator is a 1.8Vdc linear regulator which can be used to power the internal digital core of CW6626. Its corresponding grounding pin is VSS. The VDD pin is the output node of and needs to connect a decoupling circuit to VSS for best performance showing. This regulator is operating from single 1.9V to 3.6V of input supply form REG IN pin with less than 50mV of maximum dropout voltage at full load (70mA).

RVDD LDO 2.7.3.

The RVDD LDO regulator is a 2.75Vdc linear regulator which can be used to power the internal RF circuits. Its corresponding grounding pin is RVSS. The RVDD pin is the output node of and needs to connect a decoupling circuit to RVSS for best performance showing. This regulator is operating from single 3V to 5.5V of input supply form REG IN pin with less than 50mV of maximum dropout voltage at full load (80mA).

2.8. Battery-Low Detector (BLD)

The CW6626 provides a comparator as the Battery-Low Detector (BLD) to monitor the system supply power status. The internal reference voltage of BLD is 0.6Vdc and the input pin of BLD is BL VI. The CW6626 can enter power-saving mode once the voltage of BL IN is less then the internal 0.6Vdc reference voltage.





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3. Pin Assignments

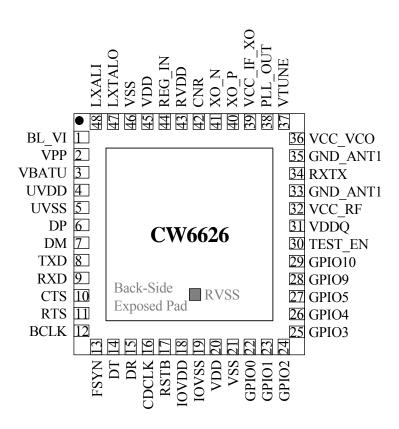


Figure 4: CW6626 QFN48 Pin Diagram(Top-View)

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Table 1: Pin Description

	*							
Pin Number	Pin Name	I/O	Power Domain	Description				
Clock/Crystal Int								
40	XO_P	I	RVDD	Crystal or frequency reference input				
41	XO_N	О	RVDD	Crystal Oscillator output. Leave unconnected if TCXO is connected to XO_P				
48	LXTALI	I	IOVDD	Low clock rate crystal driver input pin for 32KHz or 32.768KHz crystal or external clock input.				
47	LXTALO	О	IOVDD	Low clock rate crystal driver output pin for 32KHz or 32.768KHz crystal driving.				
17	RSTB	I	IOVDD	Active low system reset. This pin contains a weak pull-up				
Digital I/O and C	ore Power Supplies	}		•				
18	IOVDD	I	NA	Power supply for GPIOs.				
19	IOGND	-	NA	Ground connection of GPIOs				
44	REG_IN	I	NA	This pin serves as an input of the on-chip VDD and RVDD LDO regulators.				
20, 45	VDD	-	NA	On-chip 1.8V LDO output for digital core, this pin output typical voltage is 1.8V.				
21, 46	VSS	-	NA	Ground connection of on-chip 1.8 VDD LDO				
2	VPP	-	VDD	Internal OTP ROM power supply. Connect to VDD in application.				
RF Power Suppli	es							
15	RVDD	-	NA	On-chip 2.75V RVDD LDO output to supply internal RF circuits, this pin output typical voltage is 2.75V.				
Exposed Pad	RVSS	=	NA	Ground connection of on-chip 2.75V RVDD LDO				
31	VDDQ	I	RVDD	Digital block of RF circuit power supply. This pin must connect to RVDD.				
32	VCC_RF	I	RVDD	RF circuit power supply. This pin must connect to RVDD.				
36	VCC_VCO	I	RVDD	VCO circuit power supply. This pin must connect to RVDD.				
39	VCC_IF_XO	I	RVDD	IF and internal Crystal Oscillator circuit power supply. This pin must connect to RVDD				
42	CNR	О	RVDD	On-Chip RVDD LDO external decoupling capacitor pin.				
USB Power Supp	lies							
3	VBATU	-	NA	This pin serves as an input of the on-chip UVDD LOD regulators. Leave unconnected if this interface is not used.				
4	UVDD	-	NA	On-chip 3.3V UVDD LDO output to supply USB transceiver.				
5	UVSS	-	NA	Ground connection of on-chip 3.3V UVDD LDO				
USB Interface				•				
6	DP	I/O	UVDD	USB data plus pin, no used in this application, connect to IOVDD				
7	DM	I/O	UVDD	USB data minus pin, no used in this application, connect to IOVDD				
UART Interface								



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8	TXD	O	IOVDD	UART Serial data output port for the HCI UART
				interface. This pin should be left unconnected if UART
				is not used or can be configured to the GPIO Pin 14.
9	RXD	I	IOVDD	UART Serial data input port for the HCI UART
				interface. This pin should be left unconnected if UART
				is not used or can be configured to the GPIO Pin 15
10	CTS	I	IOVDD	UART Clear to Send-active low for HCI UART
				interface when the follow control feature enable. This
				pin should be left unconnected if UART is not used or
				can be configured to the GPIO Pin 7.
11	RTS	О	IOVDD	UART Request to Send-active low for HCI UART
				interface when the follow control feature enable. This
				pin should be left unconnected if UART is not used or
				can be configured to the GPIO Pin 7.
Audio PCM Interf	ace			*
12	BCLK	I/O	IOVDD	PCM serial data clock pin. In master mode, this is the
				clock output into the external HOST/CODEC. In clock
				slave mode, this is an input pin.
13	FSYN	O	IOVDD	PCM serial data synchronization pin. In master mode,
				this is an 8Khz sync signal to synchronize the input and
				output serial data streams.
14	DT	O	IOVDD	PCM serial data output pin. This data is clocked with
				BLCK, and first serial bit is synchronized by FSYN
15	DR	I	IOVDD	PCM serial data input pin. This data is clocked with
				BLCK, and first serial bit is synchronized by FSYN
16	CDCLK	O	IOVDD	External CODEC system clock. It can enable/disable to
				output the system clock to driver a external CODEC.
GPIO				
22, 23, 24, 25, 26,	GPIO0~GPIO	I/O	IOVDD	3.3V tolerant GPIO pin with programmable pull-up.
27, 28, 29	10			
Radio				
33, 35	GND_ANT1	-	RVDD	Ground connection of RF I/O antenna. These pins must
				connect to RVSS.
34	RXTX		RVDD	RF I/O antenna pin.
37	VTUNE	I	RVDD	VCO tune input pin.
38	PLL_OUT	O	RVDD	Charge Pump output
Battery-Low Detec				
1	BL_VI	I	VDD	The input detection pin of Battery-Low Detector
Reserved Pins				
30	TEST EN	Ī	IOVDD	The test mode enable pin. Connect to IOVSS



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4. Electrical Characteristics

4.1. Absolute Maximum Ratings

Table 2: Maximum Electrical Rating

Rating	Minimum	Maximum	Unit
Storage temperature	-40	+150	°C
Supply voltage of BATU	-0.4	5.5	V
Supply voltage of REG_IN	-0.4	3.7	V
Supply voltage of IOVDD, UVDD	-0.4	3.7	V
Supply voltage of input/output Pin	IOVSS-0.4	IOVDD+0.4	V
Supply voltage of VDD	-0.4	2.2	V
Supply voltage of RVDD, VDDQ, VCC_RF, VCC_VCO,	-0.4	3.1	V
VCC_IF_XO			

4.2. Recommended Operating Conditions

Table 3: Recommended Operating Conditions

Rating	Minimum	Typical	Maximum
Operation temperature	0 °C	+25°C	+70 °C
Supply voltage of BAT_U	3.5V	5.0V	5.5V
Supply voltage of REG_IN	3.0V	3.3V	5.5V
Supply voltage of IOVDD, UVDD	3.0V	3.3V	3.6V
Supply voltage of VDD	1.7V	1.8V	1.9V
Supply voltage of RVDD, VDDQ, VCC_RF, VCC_VCO, VCC_IF_XO	2.5V	2.75V	3.0V

4.3. Clocks

Table 4: Input Specification of XO_P/XO_P Pin

Crystal Oscillator	Minimum	Typical	Maximum
Crystal frequency	-	13, 16M,	-
		26MHz	
Crystal load capacitance	8pF	12pF	15pF
Frequency tolerance			±20ppm
Digital trim range	0pF	-	8pF
Digital trim step	-	80fF	-
External clock of XO_P ¹	Minimum	Typical	Maximum
Input frequency	-	13, 16M,	-
•		26MHz	
Clock input level	0.4Vp-p	-	RVDD
XO_P input impedance	100ΚΩ	-	-
XO_P input impedance	-	-	4pF

^{1.} Leave XO_N unconnected when use external reference clock instead of crystal.

Table 5: Signal Specification of LXTALI/LXTALO Pin

Crystal Oscillator	Minimum	Typical	Maximum

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Crystal frequency	-	32, 32.768KHz	-
Crystal load capacitance	-	20pF	-
Frequency tolerance			±200ppm
External clock of LXTALI ¹	Minimum	Typical	Maximum
Input frequency	-	32, 32.768KHz	-
Clock input level	0.4Vp-p	-	IOVDD
LXTALI input impedance	100ΚΩ	-	-
LXTALO input impedance	_	=	4pF

^{1.} Leave LXTALO unconnected when use external reference clock instead of crystal.

4.4. Linear Regulator

Table 6: UVDD LDO

UVDD Liner Regulator	Minimum	Typical	Maximum
Input voltage	3.7V	-	5.5V
Dropout voltage (I _{load} =70mA)	-	-	0.2V
Output voltage (I _{load} =70mA)	-	3.3V	-
Temperature coefficient	-	-	-
Output noise	-	=	=
Load regulation (I _{load} <70mA)	-	-	200mV/A
Maximum output current	-	-	70mA
Quiescent current	-	7uA	-

Table 7: VDD LDO

VDD Liner Regulator	Minimum	Typical	Maximum
Input voltage	1.9V	-	3.6V
Dropout voltage (I _{load} =70mA)	-	-	0.2V
Output voltage (I _{load} =70mA)	-	1.8V	-
Temperature coefficient	-	-	-
Output noise	-	-	-
Load regulation (I _{load} <70mA)	-	=	200mV/A
Maximum output current	-	-	70mA
Quiescent current	-	7uA	=

Table 8: RVDD LDO

RVDD Liner Regulator	Minimum	Typical	Maximum
Input voltage	3.0V	-	5.0V
Dropout voltage (I _{load} =70mA)	-	-	0.2V
Output voltage (I _{load} =70mA)	-	2.75V	-
Temperature coefficient	-	-	-
Output noise	-	=	-
Load regulation (I _{load} <70mA)	-	-	200mV/A
Maximum output current	-	-	80mA
Quiescent current	-	20uA	<u>-</u>



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4.5. Power Consumption

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Table 9 shows the current consumption for (IOVDD/REG_IN=2.8V, RVDD=2.5V, VDD=1.8V) $(T_A=25^{\circ}C)$ (XO_P=16MHz, LXTALI=NC) (UART HCI=921.6Kbps)

Table 9: Typical Current Consumption

Operational Mode	Minimum	Typical	Maximum
Page scan, time internal 1.28s	-	1mA	-
Inquiry	-	55mA	-
Page scan and Inquiry	-	1.6mA	-
ACL no traffic	-	26mA	-
ACL with file transfer	-	33mA	-
SCO HV3	-	23mA	-
Sleep	-	80uA	-

4.6. RF Specifications

Table 10: Receiver RF specifications

Parameter	Minimum	Typical ²	Maximum
Receiver Selection			
Frequency range	2402MHz	-	2480MHz
Rx sensitivity ¹	-84dBm	-82dBm	-80dBm
Input IP3	-21dBM	-	=
Maximum input	-	-	-10dBm
Interference Performance			
C/I co-channel (GFSK, 0.1%BER)	-	=	11 d B
C/I 1 MHz adjacent channel (GFSK, 0.1%BER)	-	-	0dB
C/I 2 MHz adjacent channel (GFSK, 0.1%BER)	-	-	-30dB
C/I >= 3 MHz adjacent channel (GFSK, 0.1%BER)	-	-	-40dB
C/I Image channel (GFSK, 0.1%BER)	-	-	-15dB
C/I co-channel (π/4-DQPSK, 0.1%BER)	-	-	=
C/I 1 MHz adjacent channel (π/4-DQPSK, 0.1%BER)	-	-	=
C/I 2 MHz adjacent channel (π/4-DQPSK, 0.1%BER)	-	-	-
$C/I >= 3$ MHz adjacent channel ($\pi/4$ -DQPSK, 0.1%BER)	-	-	=
C/I Image channel (π/4-DQPSK, 0.1%BER)	-	-	=
C/I co-channel (8-DPSK, 0.1%BER)	-	-	=
C/I 1 MHz adjacent channel (8-DPSK, 0.1%BER)	-	-	=
C/I 2 MHz adjacent channel (8-DPSK, 0.1%BER)	-	-	=
C/I >= 3 MHz adjacent channel (8-DPSK, 0.1%BER)	-	-	=
C/I Image channel (8-DPSK, 0.1%BER)	-	-	=
Intermodulation Performance			
Frequency range	-39dBm	-	-
Out-of-Band Blocking Performance (CW)			
30 MHz - 2000 MHz, 0.1% BER	<u>-</u>	_	-10dBm
2000 MHz – 2399 MHz, 01% BER	-	-	-27dBm
2498 MHz – 3000 MHz, 0.1% BER	<u>-</u>	-	-27dBm
3000 MHz – 12.75GMz, 0.1% BER	<u>-</u>	_	-10dBm
Spurious Emissions			





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30 MHz – 1 GHz	-	-	-57dBm
1 GHz -12.75 GHz	-	_	-47dBm

- 1. The receiver sensitivity is measured at a BER of 0.1% on the device interface.
- 2. Typical operating conditions are 2.75V operation voltage and 25°C ambient temperature.
- 3. The maximum value represents the actual Bluetooth specification required for Bluetooth qualification as defined in the version 2.1 specification.

Table 11: Transmitter RF specifications

Parameter	Minimum	Typical ¹	Maximum
Transmitter Selection			
Frequency range	2402MHz	-	2480MHz
Output power	-3dBm	+1dBm	+4dBm
Setting time, ±25 KHz offset	-	100us	120us
Frequency drift			
DH1 packet	-	-	±25 KHz
DH3 packet	-	-	±40 KHz
DH5 packet	-	-	±40 KHz
Modulation Index	0.28	0.32	0.35
Out-Band Spurious Emission			
30 MHz – 1 GHz idle mode	-	-	-57dBm
1 GHz -12.75 GHz idle mode	- -	-	-47dBm
1.8 GHz - 1.9 GHz	-	-	-57dBm
5.15 GHz -5.3 GHz	-	-	-47dBm

- 1. Typical operating conditions are 2.75V operation voltage and 25°C ambient temperature.
- 2. The maximum value represents the actual Bluetooth specification required for Bluetooth qualification as defined in the version 2.1 specification.
- 3. the RF characteristics are measured at the chip interface.

4.7. Timing Specifications



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5. Application Circuits

5.1. Mobile Phone Usage Model

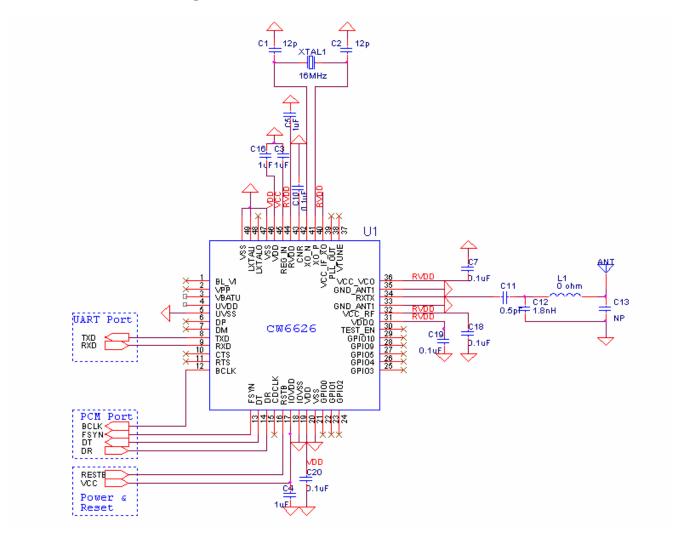


Figure 5: The Application Circuit for Mobile Phone Usage Model



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5.2. PC Product Usage Model

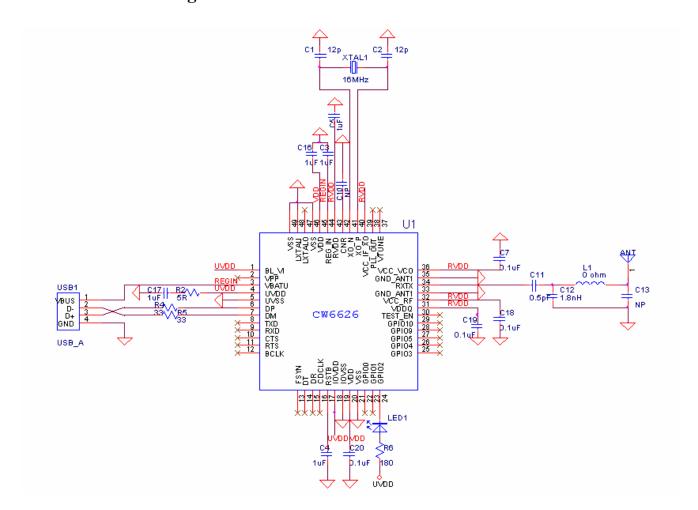


Figure 6: The Application Circuit for PC Product Usage Model





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6. Mechanical Information

6.1. 6mm X 6mm QFN48 Package Information

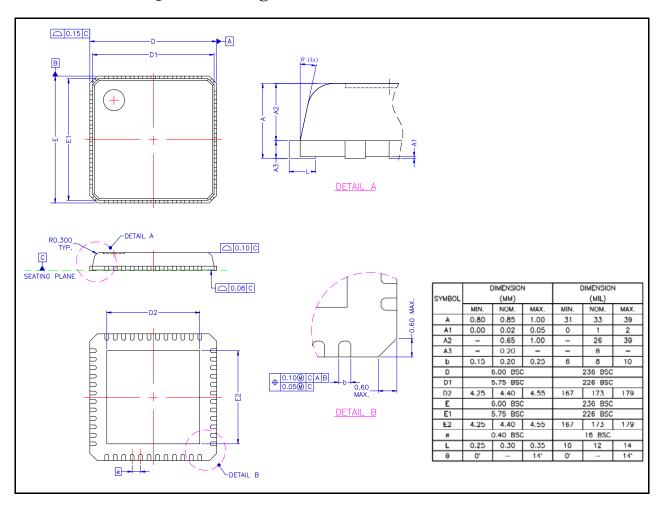


Figure 7: QFN6x6 48Pin Package Dimension



7. Ordering Information

Package		Order Number	
Type	Size	Size Shipment Method	
48-Pin QFN (Pb free)	6 x 6 x 0.85mm	Tray/Tap&Real	CW6626M

Minimum Order Quantity

Tray: 4.9Kpcs/box

Tape & Reel: 3Kpcs/reel

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8. Contact Information

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